0.3 Ω, Low Voltage Dual SPDT Analog Switches

DESCRIPTION

The DG2535E and DG2733E are low voltage, low on-resistance, dual single-pole/double-throw (SPDT) monolithic CMOS analog switches designed for high performance switching of analog signals. Combining low-power, high speed, low on-resistance, and small package size, the DG2535E and DG2733E are ideal for portable and battery powered applications.

The DG2535E and DG2733E have an operation range from 1.65 V to 5.5 V single supply. The DG2535E has two separate control pins for independent control of the two SPDT switches. The DG2733E has an EN pin to enable the device when the logic is high.

The DG2535E and DG2733E have guaranteed 1.65 V logic compatible, allowing easy interface with low voltage DSP or MCU control logic.

The switches conduct signals within the power rails equally well in both directions when on, and blocks up to the power supply level when off. Break-before-make is guaranteed.

The DG2535E and DG2733E are built on Vishay Siliconix's sub micron CMOS low voltage process technology and provide greater than 400 mA latch-up protection, as tested per JESD78A.

The DG2535E and DG2733E are available in lead (Pb)-free 10-lead DFN and SOIC packages.

FEATURES

- 1.65 V to 5.5 V single power operation
- 0.3 Ω typ. switch on resistance at V+ = 5 V
- Fast switching:
  t_{ON} = 55 ns at 2.7 V, t_{OFF} = 15 ns at 2.7 V
- Latch-up current > 400 mA (JESD78)
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

Pb-free

RoHS COMPLIANT

HALOGEN FREE

BENEFITS

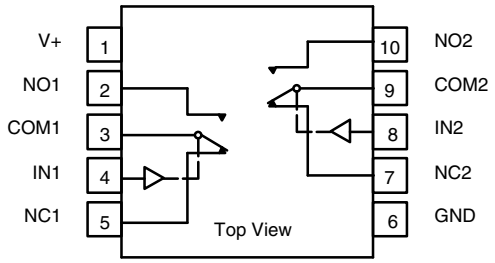
- Low switch resistance
- Low voltage logic compatible
- Wide operation voltage range
- Fast switching time

APPLICATIONS

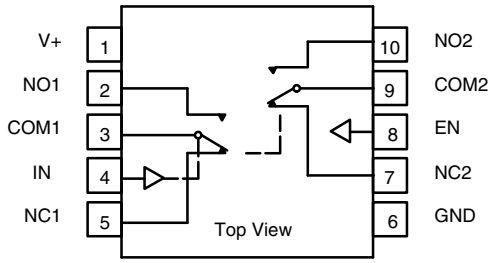
- Audio and video signal routing
- Battery operated systems
- Relay replacement
- Automatic test equipment
- Process control and automation
- Data acquisition systems
- Meters and instruments
- Medical and healthcare systems
- PCMCIA cards
- Communication systems

FUNCTIONAL BLOCK DIAGRAM AND PIN CONFIGURATION

DG2535E



DG2733E



TRUTH TABLE DG2535E		
IN1, IN2	NC1, NC2	NO1, NO2
0	ON	OFF
1	OFF	ON

TRUTH TABLE DG2733E			
IN	EN	NC1, NC2	NO1, NO2
0	1	ON	OFF
1	1	OFF	ON
0	0	OFF	OFF
1	0	OFF	OFF

ORDERING INFORMATION		
TEMP. RANGE	**PACKAGE**	**PART NUMBER**
-40 °C to +85 °C	MSOP10	DG2535EDQ-T1-GE3
		DG2733EDQ-T1-GE3
	DFN-10	DG2535EDN-T1-GE4
		DG2733EDN-T1-GE4

ABSOLUTE MAXIMUM RATINGS (T_A = 25 °C, unless otherwise noted)				
PARAMETER		**SYMBOL**	**LIMIT**	**UNIT**
Reference to GND	V+		-0.3 V to +6 V	V
	IN, COM, NC, NO [a]		-0.3 V to (V+ + 0.3)	
Current (any terminal except NO, NC or COM)			30	mA
Continuous current (NO, NC, or COM)			± 300	
Peak current (pulsed at 1 ms, 10 % duty cycle)			± 500	
Storage temperature (D suffix)			-65 to +150	°C
Power dissipation (packages) [b]	miniQFN10 [c]		208	mW
Latch up current		JESD78A	> 400	mA
ESD - HBM		ANSI / ESDA / JEDEC® JS-001	> 5000	V
ESD - CDM		JESD22-C101	> 1000	
ESD - MM		JESD22-A115	> 200	

Notes

a. Signals on NC, NO, or COM or IN exceeding V+ will be clamped by internal diodes. Limit forward diode current to maximum current ratings.
b. All leads welded or soldered to PC board.
c. Derate 4 mW/C above 70 °C.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

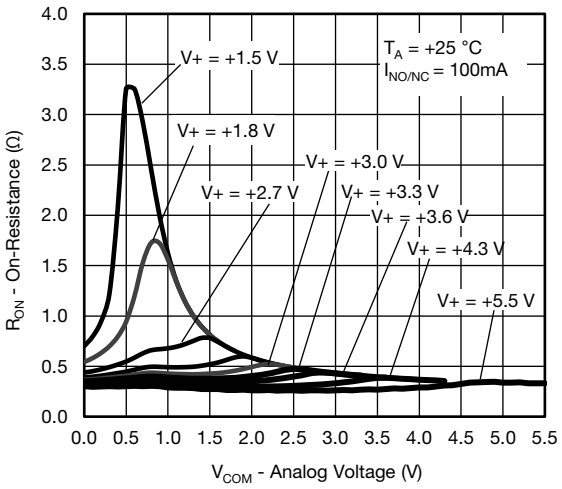
SPECIFICATIONS

PARAMETER	SYMBOL	TEST CONDITIONS UNLESS OTHERWISE SPECIFIED V+ = 3 V, ± 10 %, V_{IN} = 0.4 V or 1.65 V [e]	TEMP. [a]	LIMITS -40 °C to +85 °C MIN. [b]	TYP. [c]	MAX. [b]	UNIT
Analog Switch							
Analog signal range [d]	V_{analog}	$R_{DS(on)}$	Full	0	-	V+	V
On-resistance	$R_{DS(on)}$	V+ = 2.7 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 0.5 V	Room	-	0.5	0.7	Ω
		V+ = 2.7 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 1.5 V					
		V+ = 2.7 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 0.5 V	Full	-	0.6	-	
		V+ = 2.7 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 1.5 V					
		V+ = 5.5 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 0.9 V	Room	-	0.3	0.5	
		V+ = 5.5 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 2.5 V			0.25		
		V+ = 5.5 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 0.9 V	Full	-	0.4	-	
		V+ = 5.5 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 2.5 V					
R_{ON} match [d]	ΔR_{ON}	V+ = 2.7 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 0.5 V, 1.5 V	Room	-	0.06	0.08	
		V+ = 5.5 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 0.9 V, 2.5 V					
R_{ON} resistance flatness [d]	R_{ON} flatness	V+ = 2.7 V, $I_{NO/NC}$ = 100 mA, V_{COM} = 0.5 V, 1.5 V	Room	-	-	0.15	
Switch off leakage current	$I_{NO/NC(off)}$	V+ = 5 V, $V_{NO/NC}$ = 0.5 V / 4.5 V, V_{COM} = 4.5 V / 0.5 V	Room	-8	-	8	nA
			Full	-50	-	50	
	$I_{COM(off)}$		Room	-8	-	8	
			Full	-50	-	50	
Channel-on leakage current	$I_{COM(on)}$	V+ = 5 V, $V_{NO/NC}$ = V_{COM} = 4.5 V / 0.5 V	Room	-10	-	10	
			Full	-50	-	50	
Digital Control							
Input high voltage	V_{INH}	V+ = 3 V	Full	1.65	-	-	V
Input low voltage	V_{INL}		Full	-	-	0.4	
Input high voltage	V_{INH}	V+ = 5 V	Full	1.8	-	-	
Input low voltage	V_{INL}		Full	-	-	0.6	
Input capacitance	C_{IN}		Full	-	6	-	pF
Input current	I_{INL} or I_{INH}	V_{IN} = 0 or V+	Full	-1	-	1	µA
Dynamic Characteristics							
Break-Before-Make time [e]	t_{BBM}	V+ = 3.6 V, V_{NO}, V_{NC} = 1.5 V, R_L = 50 Ω, C_L = 35 pF	Room	1	15	-	ns
Turn-on time [e]	t_{ON}		Room	-	28	78	
			Full	-	-	80	
Turn-off time [e]	t_{OFF}		Room	-	13	58	
			Full	-	-	60	
Off-isolation [d]	OIRR	R_L = 50 Ω, C_L = 5 pF, f = 100 kHz	Room	-	-70	-	dB
Crosstalk [d]	X_{TALK}			-	-90	-	
3 dB bandwidth [d]		R_L = 50 Ω, C_L = 5 pF	Room	-	120	-	MHz
NO, NC off capacitance [d]	$C_{NO(off)}$	V_{IN} = 0 V, or V+, f = 1 MHz	Room	-	40	-	pF
	$C_{NC(off)}$			-	40	-	
Channel on capacitance [d]	$C_{NO(on)}$			-	120	-	
	$C_{NC(on)}$			-	120	-	
Power Supply							
Power supply range	V+		-	1.65	-	5.5	V
Power supply current	I+	V_{IN} = 0 or V+	Full	-	-	1	µA

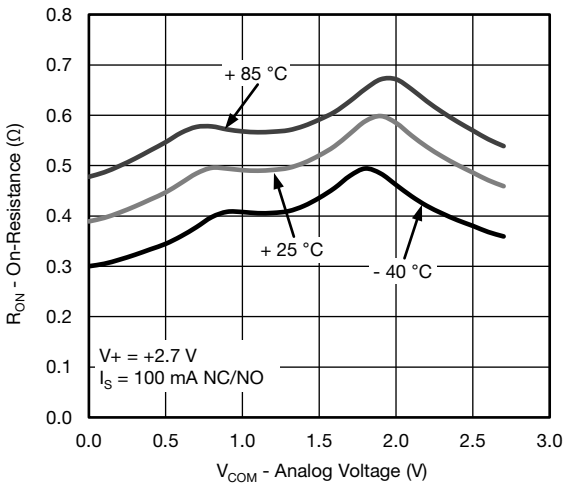
Notes

a. Room = 25 °C, Full = as determined by the operating suffix.
b. The algebraic convention whereby the most negative value is a minimum and the most positive a maximum, is used in this datasheet.
c. Typical values are for design aid only, not guaranteed nor subject to production testing.
d. Guarantee by design, not subjected to production test.
e. V_{IN} = input voltage to perform proper function.

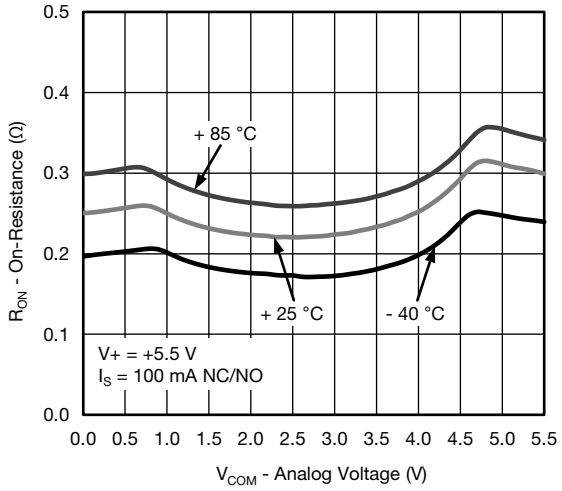
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



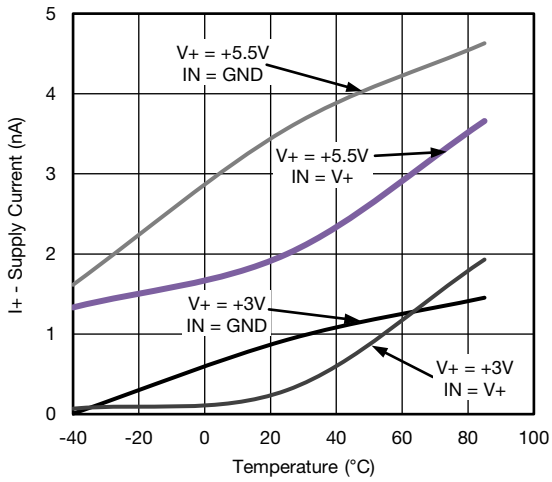
R_{ON} vs. V_{COM} and Supply Voltage



R_{ON} vs. Analog Voltage and Temperature

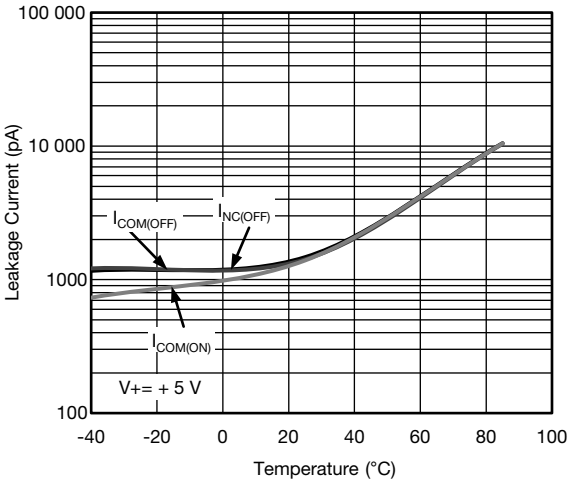


R_{ON} vs. Analog Voltage and Temperature

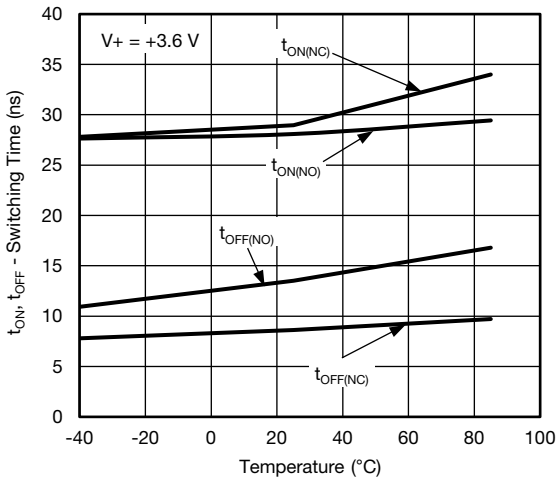


Supply Current vs. Temperature

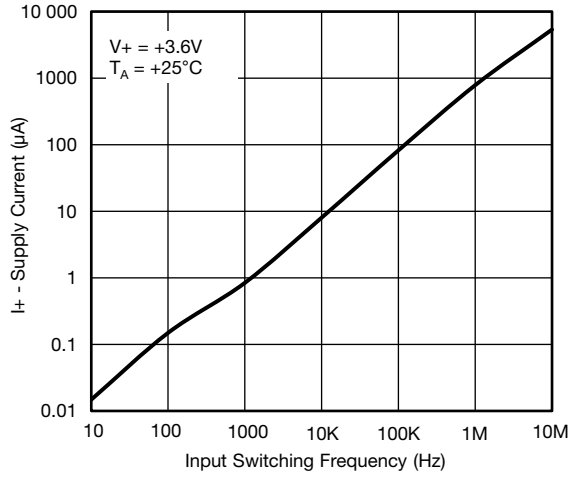
TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



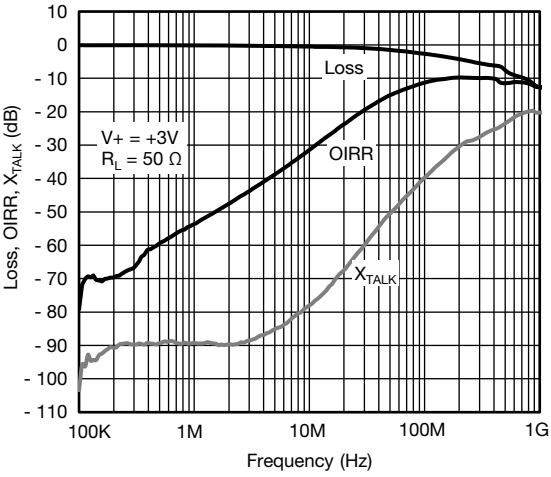
Leakage Current vs. Temperature



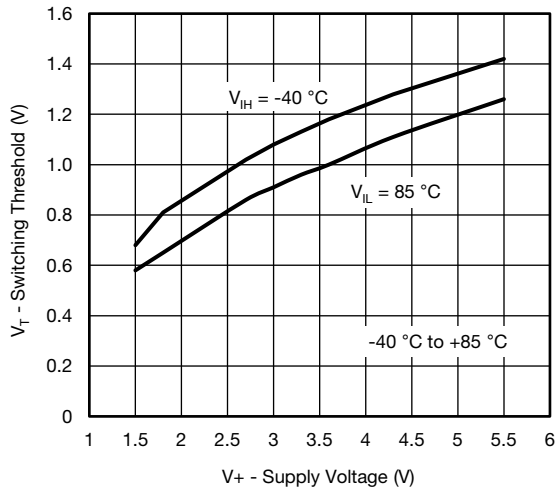
Switching Time vs. Temperature



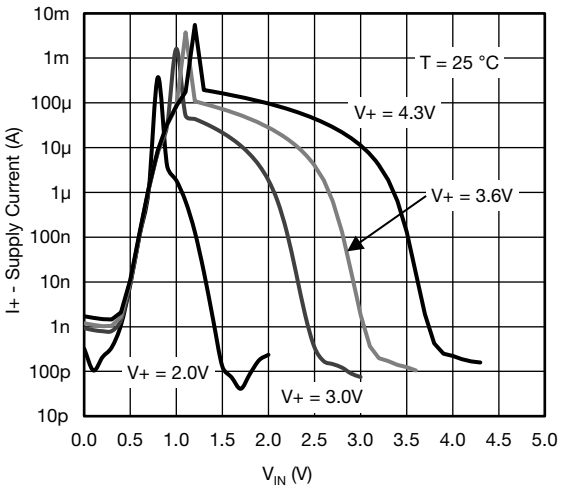
Supply Current vs. Switching Frequency



Insertion Loss, Off-Isolation Crosstalk vs. Frequency

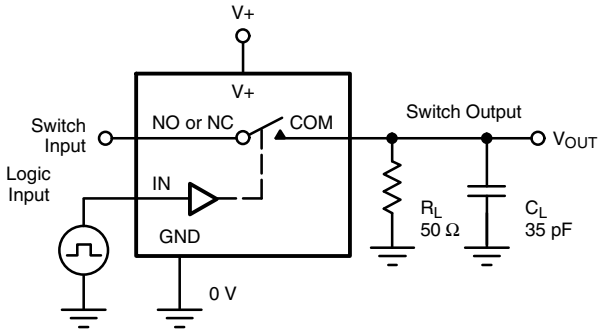


Switching Threshold vs. Supply Voltage



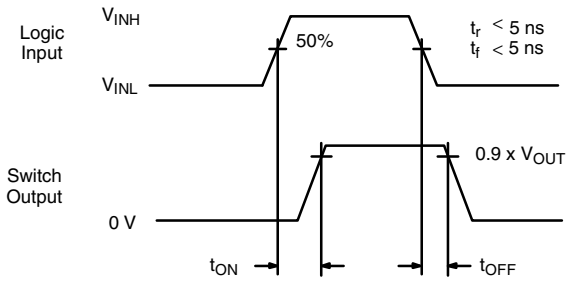
Supply Current vs. V_{IN}

TEST CIRCUITS



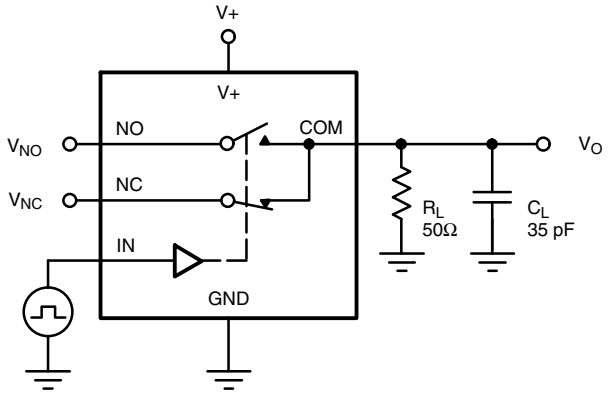
C_L (includes fixture and stray capacitance)

$$V_{OUT} = V_{COM}\left(\frac{R_L}{R_L + R_{ON}}\right)$$



Logic "1" = Switch On
Logic input waveforms inverted for switches that have the opposite logic sense.

Fig. 1 - Switching Time



C_L (includes fixture and stray capacitance)

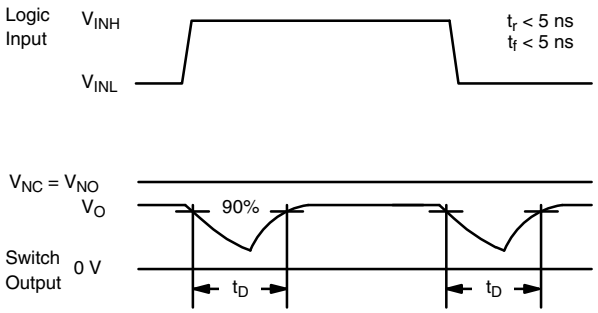
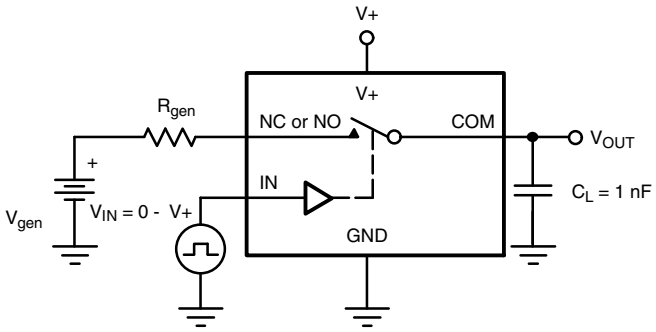
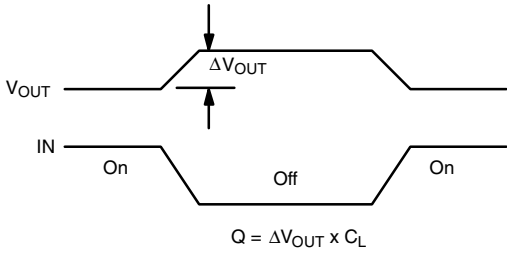


Fig. 2 - Break-Before-Make Interval

TEST CIRCUITS





IN depends on switch configuration: input polarity determined by sense of switch.

Fig. 3 - Charge Injection

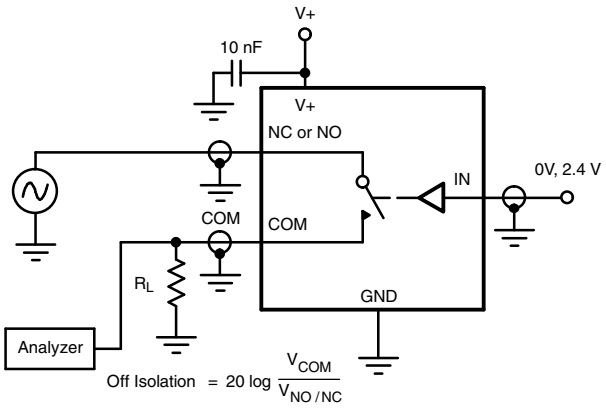


Fig. 4 - Off-Isolation

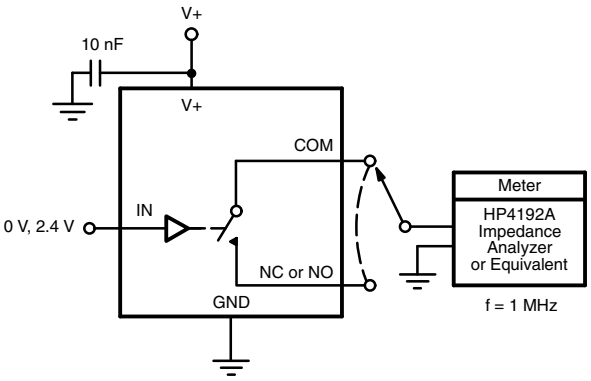
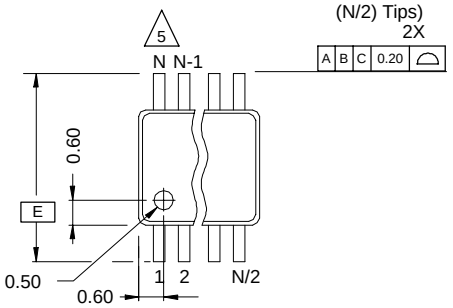


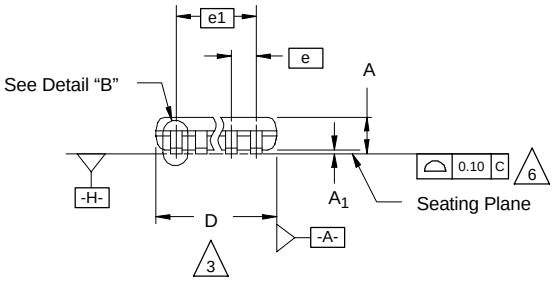
Fig. 5 - Channel Off/On Capacitance

MSOP: 10-LEADS

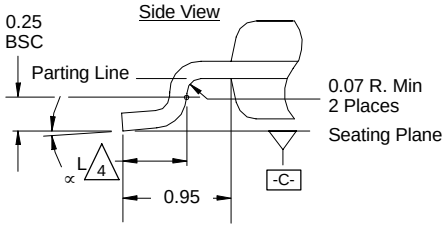
JEDEC Part Number: MO-187, (Variation AA and BA)



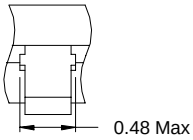
Top View



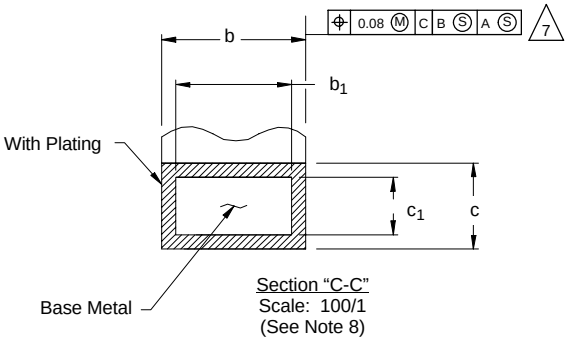
Side View



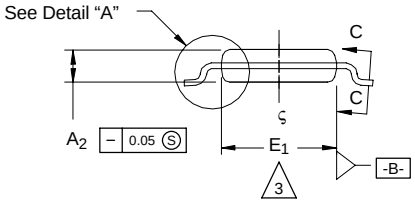
Detail "A"
(Scale: 30/1)



Detail "B"
(Scale: 30/1)
Dambar Protrusion



Section "C-C"
Scale: 100/1
(See Note 8)



End View

NOTES:

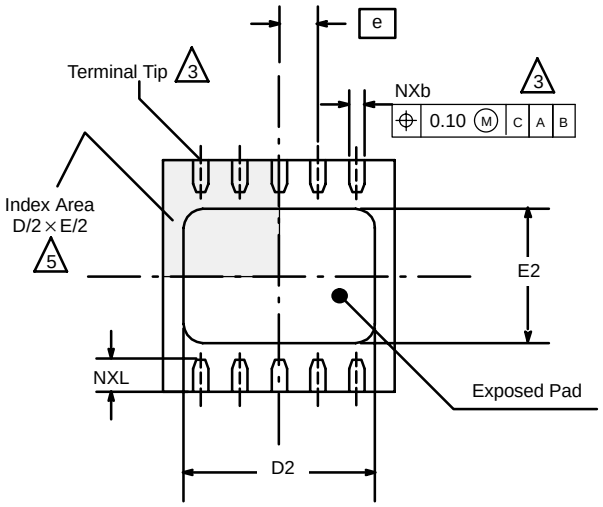
1. Die thickness allowable is 0.203 ± 0.0127.
2. Dimensioning and tolerances per ANSI.Y14.5M-1994.
3. Dimensions "D" and "E_1" do not include mold flash or protrusions, and are measured at Datum plane -H- , mold flash or protrusions shall not exceed 0.15 mm per side.
4. Dimension is the length of terminal for soldering to a substrate.
5. Terminal positions are shown for reference only.
6. Formed leads shall be planar with respect to one another within 0.10 mm at seating plane.
7. The lead width dimension does not include Dambar protrusion. Allowable Dambar protrusion shall be 0.08 mm total in excess of the lead width dimension at maximum material condition. Dambar cannot be located on the lower radius or the lead foot. Minimum space between protrusions and an adjacent lead to be 0.14 mm. See detail "B" and Section "C-C".
8. Section "C-C" to be determined at 0.10 mm to 0.25 mm from the lead tip.
9. Controlling dimension: millimeters.
10. This part is compliant with JEDEC registration MO-187, variation AA and BA.
11. Datums -A- and -B- to be determined Datum plane -H- .
12. Exposed pad area in bottom side is the same as teh leadframe pad size.

N = 10L

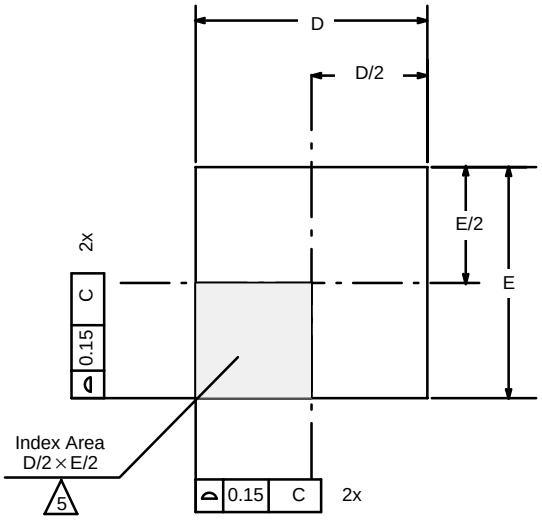
Dim	MILLIMETERS			Note
	Min	Nom	Max	
A	-	-	1.10	
A_1	0.05	0.10	0.15	
A_2	0.75	0.85	0.95	
b	0.17	-	0.27	8
b_1	0.17	0.20	0.23	8
c	0.13	-	0.23	
c_1	0.13	0.15	0.18	
D	3.00 BSC			3
E	4.90 BSC			
E_1	2.90	3.00	3.10	3
e	0.50 BSC			
e_1	2.00 BSC			
L	0.40	0.55	0.70	4
N	10			5
∝	0°	4°	6°	

ECN: T-02080—Rev. C, 15-Jul-02
DWG: 5867

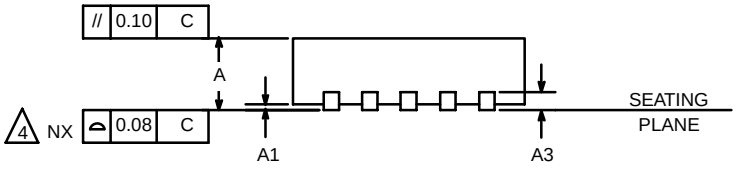
DFN-10 LEAD (3 X 3)



BOTTOM VIEW



TOP VIEW



SIDE VIEW

NOTES:

1. All dimensions are in millimeters and inches.
2. N is the total number of terminals.
3. Dimension b applies to metallized terminal and is measured between 0.15 and 0.30 mm from terminal tip.
4. Coplanarity applies to the exposed heat sink slug as well as the terminal.
5. The pin #1 identifier may be either a mold or marked feature, it must be located within the zone iindicated.

Dim	MILLIMETERS			INCHES		
	Min	Nom	Max	Min	Nom	Max
A	0.80	0.90	1.00	0.031	0.035	0.039
A1	0.00	0.02	0.05	0.000	0.001	0.002
A3		0.20 BSC			0.008 BSC	
b	0.18	0.23	0.30	0.007	0.009	0.012
D		3.00 BSC			0.118 BSC	
D2	2.20	2.38	2.48	0.087	0.094	0.098
E		3.00 BSC			0.118 BSC	
E2	1.49	1.64	1.74	0.059	0.065	0.069
e		0.50 BSC			0.020 BSC	
L	0.30	0.40	0.50	0.012	0.016	0.020

*Use millimeters as the primary measurement.

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DWG: 5943

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